



Composition, Structure, Properties Relations in Compositionally Complex and High-Entropy Alloys

Guest Editor:

Dr. Kirill V. Yusenko

Federal Institute for Materials
Research and Testing Berlin,
12489 Berlin, Germany

Deadline for manuscript
submissions:

closed (28 February 2022)

Message from the Guest Editor

Dear Colleagues,

The metallurgy of high-entropy and compositionally complex alloys is a rapidly growing field. The high-entropy approach has been adopted not only in alloy development, but also in other fields of solid-state materials research.

This Special Issue welcomes original research papers and reviews on all aspects of high-entropy and compositionally complex alloys, with a special focus on their real structure and phase transformations under temperature, pressure, and mechanical impacts, as well as the construction and modelling of multicomponent phase diagrams to access new insights into the composition–structure–properties relations in multicomponent compositionally complex alloys. Submissions are especially welcomed which might open a door to novel routes for high-entropy alloy preparation, including high-throughput and operando approaches, as well as those that might reveal new frontiers in their applications.

Dr. Kirill V. Yusenko

Guest Editor





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Maryam Tabrizian

1. Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada

2. Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

Materials (ISSN 1996-1944) was launched in 2008. The journal covers twenty-five comprehensive topics: biomaterials, energy materials, advanced composites, advanced materials characterization, porous materials, manufacturing processes and systems, advanced nanomaterials and nanotechnology, smart materials, thin films and interfaces, catalytic materials, carbon materials, materials chemistry, materials physics, optics and photonics, corrosion, construction and building materials, materials simulation and design, electronic materials, advanced and functional ceramics and glasses, metals and alloys, soft matter, polymeric materials, quantum materials, mechanics of materials, green materials, general. *Materials* provides a unique opportunity to contribute high quality articles and to take advantage of its large readership.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus, SCIE (Web of Science), PubMed, PMC, Ei Compendex, CaPlus / SciFinder, Inspec, Astrophysics Data System, and other databases.

Journal Rank: JCR - Q2 (*Metallurgy & Metallurgical Engineering*) / CiteScore - Q2 (*Condensed Matter Physics*)

Contact Us

Materials Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/materials
materials@mdpi.com
[X@Materials_Mdpi](https://twitter.com/Materials_Mdpi)